

<b>PATENT ASSIGNMENT COVER SHEET</b>
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Electronic Version v1.1  
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EPAS ID: PAT7959987

<b>SUBMISSION TYPE:</b>	CORRECTIVE ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	Corrective Assignment to correct the 2ND APPLICANTS NAME & CONVEYING PARTY EXECUTION DATES previously recorded on Reel 048647 Frame 0670. Assignor(s) hereby confirms the 2ND APPLICANTS NAME IS SHENZHEN INSTITUTE OF TERAHERTZ TECHNOLOGY AND INNOVATION & CONVEYING PARTY EXECUTION DATES ARE 2/28/21.

**CONVEYING PARTY DATA**

Name	Execution Date
SHUKAI ZHAO	02/28/2021
LINGXIA GUO	02/28/2021
CHUNCHAO QI	02/28/2021
XIONGWEI HUANG	02/28/2021
HANJIANG CHEN	02/28/2021

**RECEIVING PARTY DATA**

<b>Name:</b>	CHINA COMMUNICATION TECHNOLOGY CO., LTD.
<b>Street Address:</b>	THE 1ST FLOOR AND THE WEST PART OF 2ND FLOOR, NO. 37 BUILDING, CHENTIAN INDUSTRIAL ZONE
<b>Internal Address:</b>	1ST BAOTIAN ROAD, XIXIANG STREET, BAO'AN DISTRICT
<b>City:</b>	SHENZHEN, GUANGDONG PROVINCE
<b>State/Country:</b>	CHINA
<b>Postal Code:</b>	518102
<b>Name:</b>	SHENZHEN INSTITUTE OF TERAHERTZ TECHNOLOGY AND INNOVATION
<b>Street Address:</b>	THE EAST PART OF 2ND FLOOR, NO.37 BUILDING, CHENTIAN INDUSTRIAL ZONE
<b>Internal Address:</b>	1ST BAOTIAN ROAD, XIXIANG STREET, BAO'AN DISTRICT
<b>City:</b>	SHENZHEN, GUANGDONG PROVINCE
<b>State/Country:</b>	CHINA
<b>Postal Code:</b>	518102

**PROPERTY NUMBERS Total: 1**

Property Type	Number
<b>Application Number:</b>	16327409

**CORRESPONDENCE DATA**

**Fax Number:** (703)991-7071

*Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent*

**PATENT**

*using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.*

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**Email:** Patent@maierandmaier.com  
**Correspondent Name:** MAIER & MAIER, PLLC  
**Address Line 1:** 345 S. PATRICK ST  
**Address Line 4:** ALEXANDRIA, VIRGINIA 22314

<b>ATTORNEY DOCKET NUMBER:</b>	15060007US
<b>NAME OF SUBMITTER:</b>	CHRISTOPHER J. MAIER
<b>SIGNATURE:</b>	/Christopher J. Maier/
<b>DATE SIGNED:</b>	05/18/2023

**Total Attachments: 4**  
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ORIGINAL ASSIGNMENT

For valuable consideration, I

Shukai ZHAO of Residence Address: The 1<sup>st</sup> Floor and the West Part of 2<sup>nd</sup> Floor,  
No.37 Building, Chentian Industrial Zone  
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Chunchao QI of Residence Address: The 1<sup>st</sup> Floor and the West Part of 2<sup>nd</sup> Floor,  
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Xiongwei HUANG of Residence Address: The 1<sup>st</sup> Floor and the West Part of 2<sup>nd</sup> Floor,  
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China

Hanjiang CHEN of Residence Address: The 1<sup>st</sup> Floor and the West Part of 2<sup>nd</sup> Floor,  
No.37 Building, Chentian Industrial Zone  
1st Baotian Road, Xixiang, Bao'an District  
Shenzhen, Guangdong Province 518000  
China

the below signed joint inventors of record, hereby assign to

**CHINA COMMUNICATION TECHNOLOGY CO., LTD.**

a corporation having an address at

The 1<sup>st</sup> Floor and the West Part of 2<sup>nd</sup> Floor, No. 37 Building  
Chentian Industrial Zone  
1st Baotian Road, Xixiang Street, Bao'an District  
Shenzhen, Guangdong Province 518102.  
China

and

**SHENZHEN INSTITUTE OF TERAHERTZ TECHNOLOGY AND INNOVATION**

a corporation having an address at

The East Part of 3<sup>rd</sup> Floor, No.37 Building  
Chentian Industrial Zone  
1st Baolian Road, Xixiang Street, Bao'an District  
Shenzhen, Guangdong Province 518102  
China

and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title and interest throughout the world in the inventions and improvements which are the subject of an application for United States Patent signed by me entitled

"MILLIMETER-WAVE THREE-DIMENSIONAL HOLOGRAPHIC IMAGING METHOD AND SYSTEM"

Application Number: 16/327,809

Date of Filing: February 22, 2019

This assignment includes said application, any and all United States and foreign patents, utility models, design registrations, inventor's certificates and other similar rights granted for any of said inventions or improvements, and the right to claim priority, based on the filing date of said application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes. I hereby authorize the Assignee to apply in all countries in my name, or in its own name, for patents, utility models, design registrations and like rights of exclusion and for inventor's certificates for said inventions and improvements; and I agree for myself and my heirs, legal representatives and assignees, without further compensation to perform such lawful acts and to sign such further applications, assignments, Preliminary Statements and other lawful documents as the Assignee may reasonably request to effectuate fully this assignment.

IN WITNESS WHEREOF, I hereby set my hand, date of signature and place of signature as indicated below.

Shukai ZHAO  
Signature of Inventor

Shukai ZHAO  
Typed Name

February 28, 21  
Date of Signature

Shenzhen, China  
Place of Signature  
City, Country

Lingxia Guo  
Signature of Inventor

Lingxia GUO  
Typed Name

February 28, 21  
Date of Signature

Shenzhen, China  
Place of Signature  
City, Country

Chunchao QI  
Signature of Inventor

Chunchao QI  
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Xiongwei HUANG  
Signature of Inventor

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Place of Signature  
City, Country

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Signature of Inventor

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Typed Name

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Date of Signature

Shenzhen, China  
Place of Signature  
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## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
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EPAS ID: PAT5431124

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT

**CONVEYING PARTY DATA**

Name	Execution Date
SHUKAI ZHAO	02/28/2019
LINGXIA GUO	02/28/2019
CHUNCHAO QI	02/28/2019
XIONGWEI HUANG	02/28/2019
HANJIANG CHEN	02/28/2019

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**ATTORNEY DOCKET NUMBER:** 27110-18

**NAME OF SUBMITTER:** JASON P. MUELLER

**SIGNATURE:** /Jason P. Mueller/

**DATE SIGNED:** 03/20/2019

**Total Attachments: 2**

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